

High Precision Foil Resistor

with TCR of ±2.0 ppm/°C, Tolerance of ±0.01% and Load Life Stability of ±0.005% CECC Qualified

FEATURES

- Temperature coefficient of resistance (TCR): ±2 ppm/°C typical (-55°C to +155°C, ref. +20°C)
- Resistance range: 80.6 Ω to 120 k Ω
- Foil resistors are not restricted to standard values; specific "as required" values can be supplied at no extra cost or delivery (e.g., 1K2345 vs. 1K)
- Rated power: to 0.25 W at +125°C
- Tolerance: ±0.01%
- Load life stability: to ±0.005% at 70°C, 2000 h at rated power
- Electrostatic discharge up to 25 000 V
- Non inductive, non capacitive design
- Rise time: 1 ns effectively no ringing
- Current noise: <-40 dB
- Thermal EMF: 0.05 μV/°C typical
- Voltage coefficient: <0.1 ppm/V
- Low inductance: <0.08 μH typical
- Non hot spot design
- Terminal finish available: tin/lead alloy
- Matched sets are available per request
- (TCR Tracking: to 0.5 ppm/°C)
- For better TCR and PCR performances please review the RNC90Z and Z555 datasheets

INTRODUCTION

Bulk Metal® Foil (BMF) technology out performs all other resistor technologies available today for applications that require high precision and high stability.

This technology has been pioneered and developed by VFR and products based on this technology are the most suitable for a wide range of applications.



BMF technology allows us to produce customer orientated products, designed to satisfy challenging and specific technical requirements.

Models RS92N, RS92NA, and AN made from BMF offers low TCR, excellent load life stability, tight tolerance, fast response time, low current noise, low thermal EMF and low voltage coefficient, all in one resistor.

The RS92N, RS92NA, and AN are virtually insensitive to destabillizing factors. The resistor element is a solid alloy that displays the desirable bulk properties of its parent material, thus it is inherently stable and noise free.

VFR Bulk Metal® RS92N, RS92NA, and AN resistors are the modern generation of precision resistors. The standard design of these resistors provides a unique combination of characteristics found in no other single resistor.

Our Application Engineering Department is available to advise and to make recommendations. For non-standard technical requirements and special applications, please contact us.

Table 1 - Tolerance and TCR vs. Resistance Value (-55°C to +155°C, +20°C Ref.)				
RESISTANCE VALUE (Ω) TOLERANCE (%)		TYPICAL TCR AND MAX. SPREAD (ppm/°C)		
80.6 to 120K	±0.01	±2±3		

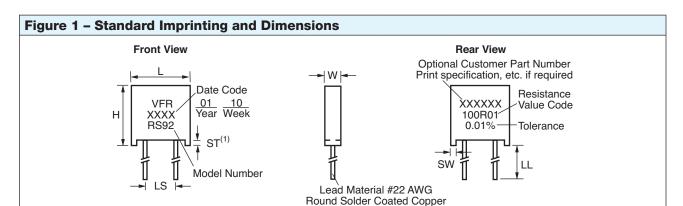
Table 2 - Mechanical and Environmental Specifications			
Mechanical Protection	Insulated case		
Resistive Element	Nickel-chromium		
Unit Weight	0.3 g		
Temperature Limits	−55°C to +155°C		
Climatic Category	55/155/56		



Table 3 - Electrical Specifications				
Qualified Ohmic Range	RS92N, RS92NA	80R6 to 120K		
	AN	80R6 to 92K		
Qualified Tolerances		0.01% to 1%		
Power Rating		0.5 W at +70°C 0.25 W at +125°C		
Temperature Coefficient		see diagram		
Dielectric Strength		700 VAC		
Insulation Resistance		>10 ⁴ MΩ		
Thermal EMF		<0.5 µV for 1°C of difference between leads		
Noise		non measureable		
Thermal Resistance		0.14°C/mW		

Table 4 - Performance					
TESTS	CONDITIONS	REQUIREMENTS C 83-220 CECC 40302-001	TYPICAL DRIFTS		
Overload	2.5 U _n /5 s U _{max} . <2 U _n	±0.01%	±0.002%		
Temperature Cycling	–55°C to +155°C, 5 cycles CEI 68-2-14 test Na	±0.01%	±0.003%		
Terminals Strength	CEI 68-2-21 test Ua (pulling), Ub (bending), Uc (twisting)	±0.01%	±0.002%		
Resistance to Soldering Heat	260°C/10 s CEI 68-2-20A test Tb (method 1A)	±0.01%	±0.002%		
Vibrations	10 Hz to 500 Hz 0.75 mm or 10g for 6 h method B4 CEI 68-2-6 test Fc	±0.01%	±0.002%		
Climatic Sequence	–55°C to +155°C, 6 cycles, 95% R.H., 85 mbar CEI 68-1	$\pm 0.05\%$ Insulation R >10² M Ω	±0.003% Insulation R >10⁴ MΩ		
Humidity (Steady State) 56 days, 95% R.H., 40°C CEI 68-2-3		$\pm 0.05\%$ Insulation R >10² M Ω	$\pm 0.003\%$ Insulation R >104 M Ω		
Load Life	1000 h Pr at +70°C 90'/30' cycle	±0.05%	±0.01%		
High Temperature Exposure	1000 h/155°C CEI 68-2-20A test B	±0.05%	±0.01%		

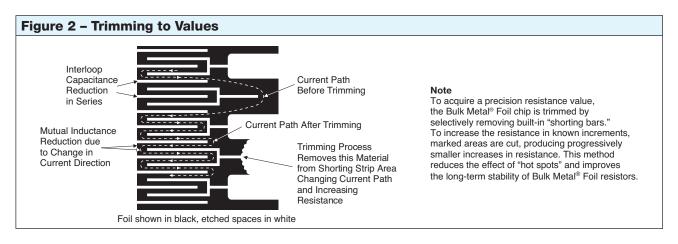


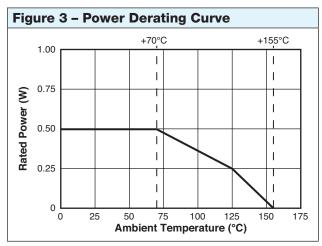


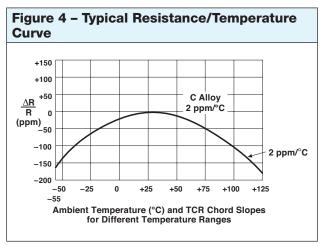
Note

(1) The standoffs shall be so located as to give a lead clearance of 0.010 in minimum between the resistor body and the printed circuit board when the standoffs are seated on the printed circuit board. This is to allow for proper cleaning of flux and other contaminants from the unit after all soldering processes.

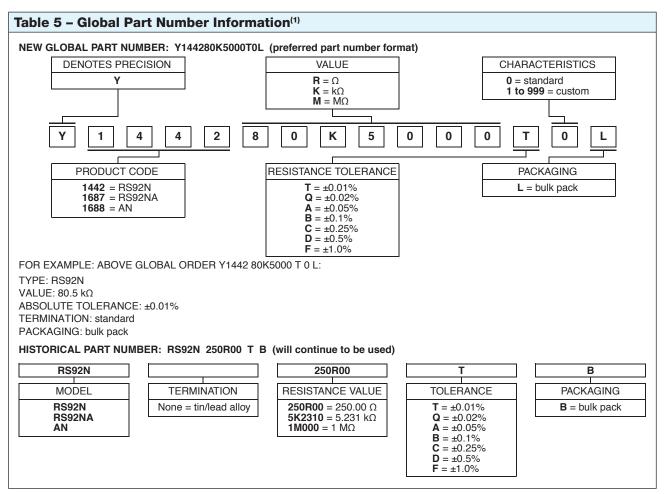
MODEL	DIM.	LS	W	L	н	ST	LL	WEIGHT NOMINAL
RS92NA	mm	3.81±0.13	2.50 max.	7.50 max.	8.00 max.	0.254 min.	25.4 min.	0.6 g
RS92N	mm	5.08±0.076	2.50 max.	7.50 max.	8.00 max.	0.254 min.	25.4 min.	0.6 g
AN	mm	5.08±0.076	2.50 max.	7.50 max.	8.00 max.	0.254 min.	25.4 min.	0.6 g











Note

⁽¹⁾ For non-standard requests, please contact application engineering.